RoHS

COMPLIANT

HALOGEN FREE

<u>GREEN</u>



Vishay Semiconductors

High Power Infrared Emitting Diode, 810 nm, Surface Emitter Technology



DESCRIPTION

As part of the <u>SurfLight</u>TM portfolio, the VSMY98145DS is an infrared, 810 nm emitting diode based on surface emitter technology with high radiant power and high speed, molded in low thermal resistance SMD package with lens. A 42 mil chip provides outstanding radiant intensity and allows DC operation of the device up to 1 A. Superior ESD characteristics are ensured by an integrated Zener diode.

FEATURES

- · Package type: surface mount
- Double stack technology
- Package form: high power QFN with lens
- Dimensions (L x W x H in mm): 3.85 x 3.85 x 2.24
- Peak wavelength: λ_p = 810 nm
- · Zener diode for ESD protection up to 2 kV
- High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 45^{\circ}$
- Designed for high drive currents: up to 1 A (DC) and up to 5 A pulses
- Low thermal resistance: R_{thJA} = 10 K/W
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Infrared illumination for CMOS cameras (CCTV)
- Iris scan
- Machine vision

| PRODUCT SUMMARY | | | | | |
|-----------------|------------------------|---------|-----------------------------|---------------------|--|
| COMPONENT | I _e (mW/sr) | φ (deg) | $\lambda_{\mathbf{p}}$ (nm) | t _r (ns) | |
| VSMY98145DS | 500 | ± 45 | 810 | 30 | |

Note

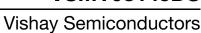
Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION | | | | | |
|----------------------|---------------|----------------------------|----------------------|--|--|
| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM | | |
| VSMY98145DS | Tape and reel | MOQ: 600 pcs, 600 pcs/reel | High power with lens | | |

Note

· MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | |
|---|-------------------------------|-------------------|-------------|------|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | |
| Reverse voltage | | V _R | 5 | V | |
| Forward current | | I _F | 1 | А | |
| Surge forward current | t _p = 10 μs | I _{FSM} | 5 | А | |
| Power dissipation | | P _V | 3.8 | W | |
| Junction temperature | | Tj | 115 | °C | |
| Operating temperature range | | T _{amb} | -40 to +85 | °C | |
| Storage temperature range | | T _{stg} | -55 to +100 | °C | |
| Soldering temperature | According to fig. 7, J-STD-20 | T _{sd} | 260 | °C | |
| Thermal resistance junction / pin | JESD51 | R _{thJP} | 10 | K/W | |





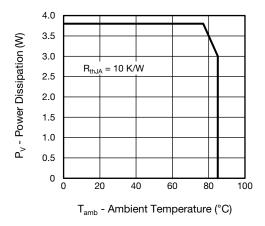


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

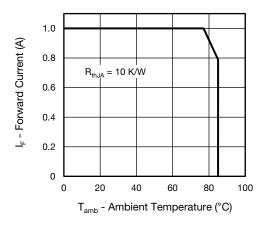


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|--|---|----------------|------|------|------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | $I_F = 1 \text{ A}, t_p = 100 \mu\text{s}$ | V _F | - | 3.3 | 3.8 | V |
| | $I_F = 2 A, t_p = 100 \mu s$ | V _F | - | 3.5 | - | V |
| Reverse current | V _R = 5 V | I _R | - | - | 10 | μΑ |
| Radiant intensity | $I_F = 1 \text{ A}, t_p = 100 \mu\text{s}$ | l _e | 350 | 500 | - | mW/sr |
| | $I_F = 2 A, t_p = 100 \mu s$ | l _e | - | 950 | - | mW/sr |
| Radiant power | $I_F = 1 A, t_p = 20 ms$ | φ _e | - | 1000 | - | mW |
| Angle of half intensity | | φ | - | ± 45 | - | deg |
| Peak wavelength | I _F = 1 A | λ_{p} | - | 810 | - | nm |
| Spectral bandwidth | I _F = 1 A | Δλ | - | 50 | - | nm |
| Rise time | I _F = 1 A | t _r | - | 30 | - | ns |
| Fall time | I _F = 1 A | t _f | - | 30 | - | ns |

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

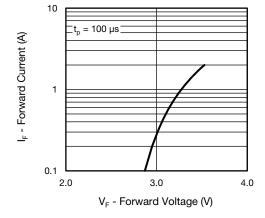


Fig. 3 - Forward Current vs. Forward Voltage

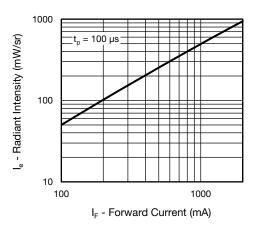
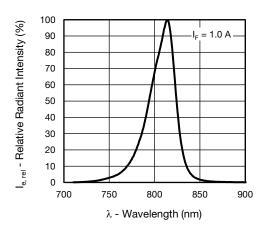
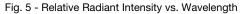


Fig. 4 - Radiant Intensity vs. Forward Current

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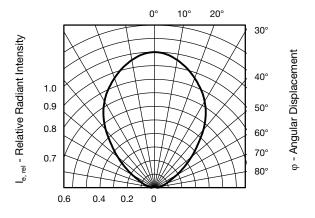
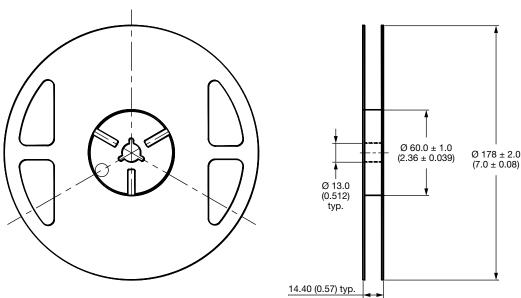


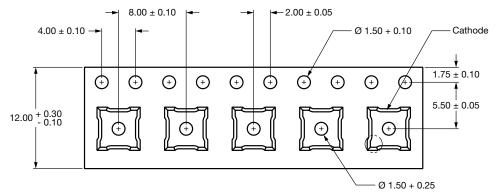
Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

TAPING DIMENSIONS in millimeters



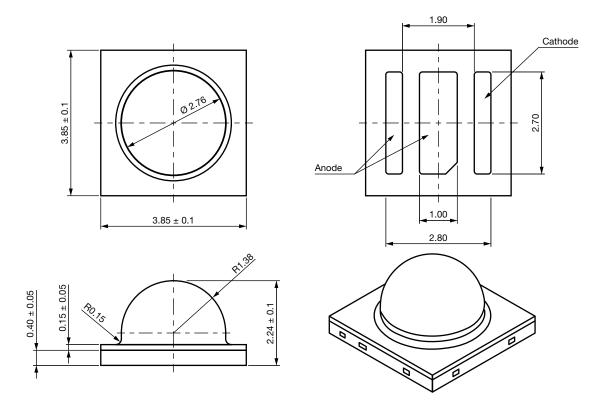
Notes

- Empty component pockets sealed with top cover tape.
- 7 inch reel 600 pieces per reel.
- The maximum number of consecutive missing lamps is two.
- In accordance with ANSI / EIA 481-1-A-1994 specifications.



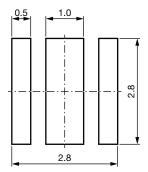
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PACKAGE DIMENSIONS in millimeters



Notes

- Tolerance is \pm 0.10 mm (0.004") unless otherwise noted.
- Specifications are subject to change without notice.



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SOLDER PROFILE

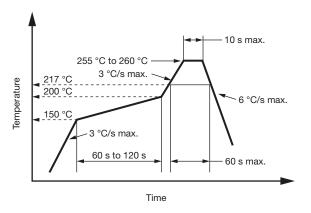


Fig. 7 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



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